

## PCN#20230412001.1 Qualification of a new Die Attach Material for select devices

## Change Notification / Sample Request

Date: April 12, 2023 To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If additional data is required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (<u>PCN ww admin team@list.ti.com</u>). For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

PCN Team SC Business Services

## 20230412001.1 Attachment: 1

# **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
DRV8818PWPR	null
TPA3113D2PWPR	null
LM5176PWPR	null
TPA3118D2DAPR	null
TPA3110D2PWP	null
TPA3110D2PWPR	null
TPA3138D2PWPR	null
TAS5805MPWPR	null
DRV8876PWPR	null
DRV8876PWPT	null
DRV8840PWP	null
LM5176PWPT	null
DRV8840PWPR	null
TPA3138D2PWP	null
DRV8818PWP	null
SN005805PWPR	null
TPA3130D2DAPR	null
TLS2605RDCARG4	GDM460002751
TPA3130D2DAP	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	001.1	01.1				ate:	April 12, 2023			
Title: Qualification of a new die attach material for select devices										
Customer Cont	act: PCN A	<u>Nanager</u>	Dept:	Quality Servio	es					
Proposed 1 <sup>st</sup> Ship Date: Jul 11,		2023	2023 Sample r		d until: May 12, 2023					
*Sample reque	sts receive	d after	May 12, 2							
Change Type:										
Assembly Site			_	Design (			Wafer Bump Site Wafer Bump Material			
Assembly Pr			Data Sheet							
Assembly M Mechanical				☐ Part number change ☐ Test Site			Wafer Bump Process Wafer Fab Site			
Packing/Shi			_	Test Process				Materials		
	op in 9/ 2000 in	.9		[				Process		
			PCN	Details						
Description of Change:										
This PCN is to inform of an alternate die attach material for the devices listed below.										
,	What			Current		New				
Die attach material			4208458		4211470					
Reason for Cha	nge:									
Continuity of supply										
Anticipated imp	pact on For	m, Fit,	Function,	Quality or Re	lia bilit	y (posit	ive / I	negative):		
None										
Impact on Envi	ronmental	Rating	S							
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.										
RoHS		EACH Green Statu			s	IEC	C 62474			
🛛 No Change	e 🛛	🛾 No Ch	ange 🛛 🛛 No Change			$\square$	🛛 No Change			
Changes to pro	duct identi	ficatior	n resulting	from this PC	N:					
None										
Product Affecte	ed:									
DRV10987SLIPW		R LM5176PWPR				TPA3113D2PWPR				
DRV8818PWP		LM5176PWPT		TAS5806MDDCP		TPA3118D2DAP				
DRV8818PWPR		SN005805PWPR		TAS5806MDDCPR		TPA3118D2DAPR				
DRV8840PWP		C0183PW				TPA3130D2DAP				
DRV8840PWPR		C0183PW				TPA3130D2DAPR				
DRV8876NPWPR		9039DCF				TPA3138D2PWP				
DRV8876NPWPT		5805M0P		TPA3110D2PWP		TPA3138D2PWPR				
DRV8876PWPR	TAS5805MPWP		TPA3110D2PWF	LOD2PWPR		TPS8802DCPR				

DRV8876PWPT TAS5805MPWPR TPA3113D2PWP
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TI Information Selective Disclosure

## **Qualification Report**

#### Approve Date 07-APRIL -2023

## **Qualification Results**

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>TAS5807MDCPR</u>	Qual Device: <u>TLS2605RDCARG4</u>	QBS Reference: LP8880DCPRQ1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	3/231/0	3/231/0	3/231/0
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	3/231/0	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	175C	500 Hours	-	-	3/135/0
SD	C3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	-	1/15/0
PD	C4	Physical Dimensions	Cpk>1.67	-	-	-	3/30/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	-
CHAR	E5	Electrical Distributions	Cpk>1.67 Room, hot, and cold	-	-	-	3/90/0

• QBS: Qual By Similarity

• Qual Device TAS5807MDCPR and TLS2605RDCARG4 are qualified at MSL3 260C

• Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

TI Qualification ID: R-CHG-2207-055

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW Change Management Team	PCN ww admin team@list.ti.com

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